



# Product Change Notification

**Change Notification #:** 116550 - 01  
**Change Title:** Intel® Dual Band Wireless-AC 8265, 2230, SKUs: 8265.NGWMG, 8265.NGWMG.NV, 8265.NGWMG.S, 8265.NGWMG.NVS, 8265.NGWMG.K, 8265.NGWMG.NVK & **8265.NGWMG.DTX1**  
PCN 116550-01, Label, Label Update  
**Reason for Revision: Adding Product Code**

**Date of Publication:** December 13, 2018

## Key Characteristics of the Change:

Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	November 12, 2018
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## Description of Change to the Customer:

### Reason for Revision: Adding Product Code 8265.NGWMG.DTX1

The Intel® Wireless-AC 8265 2230 SKUs listed in the products affected table below will undergo the following changes:

1. Date code tables are being updated for 2019/2020.
2. The Intel tracking revision will be changed on the following products

Product	Before	After
8265.NGWMG	0F	0G
8265.NGWMG.DTX1	0F	0G
8265.NGWMG.NV	0F	0G

Label Artwork (Before/After)

Product Code	Product Label (Before)	Product Label (After)
<p>8265.NGWMG</p> <p>8265.NGWMG.DTX1(use the same product label because 8265.NGWMG is part of the components in DTX1 kit)</p>		

Product Code	IBL Label (Before)	IBL Label (After)
8265.NGWMG		

Product Code	Product Label (Before)	Product Label (After)
<p>8265.NGWMG.NV</p>		

Product Code	IBL Label (Before)				
8265.NGWMG .NV	<b>8265.XXXXXXXX</b>  QTY: 100 VERSION #: J29844-006 MM#: XXXXXX MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX BATCH #: CCVYMDRSS	 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS	 1 88334 00140 2 9 310779 300005	<b>Intel® Dual Band Wireless-AC 8265 (Model: 8265NGW)</b> PKG ID (S) VVVVMMMMDDDDzzzzPPPPPP100 T P/N: G8C0007J610 D P/N: P P P P P P REV AX X HP P/N: 851593-001 REV: 0G Vendor ID   Loc Id Mfg Id M M M M M M L P/N: XXXXXXXXXX VVVVVLLLLL M M M M M M EC: XXXXXXXX	       Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1949 USA www.intel.com CMIT ID: 2016AJ2775 (M) MSP-CRM-INT-8265NGW
	IBL Label (After)				
	<b>8265.XXXXXXXX</b>  QTY: 100 VERSION #: J29844-007 MM#: XXXXXX MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX BATCH #: CCVYMDRSS	 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS	 1 88334 00140 2 9 310779 300005	<b>Intel® Dual Band Wireless-AC 8265 (Model: 8265NGW)</b> PKG ID (S) VVVVMMMMDDDDzzzzPPPPPP100 T P/N: G8C0007J610 D P/N: P P P P P P REV AX X HP P/N: 851593-001 REV: 0G Vendor ID   Loc Id Mfg Id M M M M M M L P/N: XXXXXXXXXX VVVVVLLLLL M M M M M M EC: XXXXXXXX	       Intel Corp 2200 Mission College Blvd Santa Clara, CA 95054-1949 USA www.intel.com CMIT ID: 2016AJ2775 (M) MSP-CRM-INT-8265NGW

8265.NGWMG.S	<b>J30628-003</b> 	<b>Intel® Model: 8265NGW</b> T P/N: G86C0007J710 SPS : XXXXXX-XXX XX WFM: OOOOOOXXXXXX BDM: OOOOOOXXXXXX FCC ID: PD98265NG MM: XXXXXX TA: J29895-006 FRU P/N: 01AX703 EC: 273698 8SSW10K97448 T1SSYMDXXXX Made in China   IC :1000M-8265NG Anatel: 03877-16-02198 PTA APPROVED MODEL	<b>J30628-003</b> 	<b>Intel® Model: 8265NGW</b> T P/N: G86C0007J710 SPS : XXXXXX-XXX XX WFM: OOOOOOXXXXXX BDM: OOOOOOXXXXXX FCC ID: PD98265NG MM: XXXXXX TA: J29895-007 FRU P/N: 01AX703 EC: 273698 8SSW10K97448 T1SSYMDXXXX Made in China   IC :1000M-8265NG Anatel: 03877-16-02198 PTA APPROVED MODEL
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Product Code	IBL Label (Before)				
8265.NGWMG .S	<b>8265.XXXXXXXX</b>  QTY: 100 VERSION #: J29895-006 MM#: XXXXXX MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX BATCH #: CCVYMDRSS	 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS	 1 88334 00140 2 9 310779 300005	<b>Intel® Dual Band Wireless-AC 8265 (Model: 8265NGW)</b> PKG ID (S) VVVVMMMMDDDDzzzzPPPPPP100 T P/N: G8C0007J710 D P/N: P P P P P P REV AX X HP P/N: XXXXXX-XXX REV: XX Vendor ID   Loc Id Mfg Id M M M M M M L P/N: XXXXXXXXXX VVVVVLLLLL M M M M M M EC: XXXXXXXX	       Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1949 USA www.intel.com CMIT ID: 2016AJ2775 (M) MSP-CRM-INT-8265NGW
	IBL Label (After)				
	<b>8265.XXXXXXXX</b>  QTY: 100 VERSION #: J29895-007 MM#: XXXXXX MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX BATCH #: CCVYMDRSS	 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS	 1 88334 00140 2 9 310779 300005	<b>Intel® Dual Band Wireless-AC 8265 (Model: 8265NGW)</b> PKG ID (S) VVVVMMMMDDDDzzzzPPPPPP100 T P/N: G8C0007J710 D P/N: P P P P P P REV AX X HP P/N: XXXXXX-XXX REV: XX Vendor ID   Loc Id Mfg Id M M M M M M L P/N: XXXXXXXXXX VVVVVLLLLL M M M M M M EC: XXXXXXXX	       Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1949 USA www.intel.com CMIT ID: 2016AJ2775 (M) MSP-CRM-INT-8265NGW



Product Code	IBL Label (Before)			IBL Label (After)		
8265.NGWMG .K	<b>8265.XXXXXXXX</b>  VERSION #: J31538-007  MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX	<b>MM#: XXXXXX</b>  PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS	<b>QTY: 100</b>  1 88334 00140 2 9 310779 300005	<b>Intel® Dual Band Wireless-AC 8265 (Model: 8265NGW)</b> PKG ID (3S) VVVVMMMMDDDD#####PPPP100  T P/N: GTTTTTTTTTT D P/N: PPPPPP REV AXX HP P/N: XXXXXX-XXX REV: XX  PACKAGE WEIGHT: X.X LBS Vendor ID   Loc Id Mfg Id VVVVVLLLLL MMSMM L P/N: SW10K97474 EC: 336605	   CMAA16LP120277 CMIT ID: 2016A2775 (M)  CNC ID: C-16376 CNC ID: C-16386 CNC ID: C-16473  E33-18104 T1350-26-095 D16055003  MSP-CRM-INT-8265NGW	Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com
	<b>8265.XXXXXXXX</b>  VERSION #: J31538-008  MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX	<b>MM#: XXXXXX</b>  PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS	<b>QTY: 100</b>  1 88334 00140 2 9 310779 300005	<b>Intel® Dual Band Wireless-AC 8265 (Model: 8265NGW)</b> PKG ID (3S) VVVVMMMMDDDD#####PPPP100  T P/N: GTTTTTTTTTT D P/N: PPPPPP REV AXX HP P/N: XXXXXX-XXX REV: XX  PACKAGE WEIGHT: X.X LBS Vendor ID   Loc Id Mfg Id VVVVVLLLLL MMSMM L P/N: SW10K97474 EC: 336605	   CMAA16LP120277 CMIT ID: 2016A2775 (M)  CNC ID: C-16376 CNC ID: C-16386 CNC ID: C-16473  E33-18104 T1350-26-095 D16055003  MSP-CRM-INT-8265NGW	Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com

Product Code	Product Label (Before)	Product Label (After)
8265. NGWMG.NVK	<b>J30628-003</b>  <b>Intel® Model: 8265NGW</b> T P/N: GTTTTTTTTTT SPS : XXXXXX-XXX XX WFM: OOOOOOXXXXXX BDM: OOOOOOXXXXXX FCC ID: PD98265NG MM: XXXXXX TA: J31579-007 FRU P/N: 01AX722 EC: 336616  MAIN 2 AUX 1 8SSW10K97476 T1SSYMDXXXX Made in China   IC :1000M-8265NG Anatel: 03877-16-02198 PTA APPROVED MODEL	<b>J30628-003</b>  <b>Intel® Model: 8265NGW</b> T P/N: GTTTTTTTTTT SPS : XXXXXX-XXX XX WFM: OOOOOOXXXXXX BDM: OOOOOOXXXXXX FCC ID: PD98265NG MM: XXXXXX TA: J31579-008 FRU P/N: 01AX722 EC: 336616  MAIN 2 AUX 1 8SSW10K97476 T1SSYMDXXXX Made in China   IC :1000M-8265NG Anatel: 03877-16-02198 PTA APPROVED MODEL

Product Code	IBL Label (Before)			IBL Label (After)		
8265.NGWMG .NVK	<b>8265.XXXXXXXX</b>  VERSION #: J31579-007  MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX	<b>MM#: XXXXXX</b>  PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS	<b>QTY: 100</b>  1 88334 00140 2 9 310779 300005	<b>Intel® Dual Band Wireless-AC 8265 (Model: 8265NGW)</b> PKG ID (3S) VVVVMMMMDDDD#####PPPP100  T P/N: GTTTTTTTTTT D P/N: PPPPPP REV AXX HP P/N: XXXXXX-XXX REV: XX  PACKAGE WEIGHT: X.X LBS Vendor ID   Loc Id Mfg Id VVVVVLLLLL MMSMM L P/N: SW10K97474 EC: 336616	   CMAA16LP120277 CMIT ID: 2016A2775 (M)  CNC ID: C-16376 CNC ID: C-16386 CNC ID: C-16473  E33-18104 T1350-26-095 D16055003  MSP-CRM-INT-8265NGW	Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com
	<b>8265.XXXXXXXX</b>  VERSION #: J31579-008  MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXX	<b>MM#: XXXXXX</b>  PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS	<b>QTY: 100</b>  1 88334 00140 2 9 310779 300005	<b>Intel® Dual Band Wireless-AC 8265 (Model: 8265NGW)</b> PKG ID (3S) VVVVMMMMDDDD#####PPPP100  T P/N: GTTTTTTTTTT D P/N: PPPPPP REV AXX HP P/N: XXXXXX-XXX REV: XX  PACKAGE WEIGHT: X.X LBS Vendor ID   Loc Id Mfg Id VVVVVLLLLL MMSMM L P/N: SW10K97474 EC: 336616	   CMAA16LP120277 CMIT ID: 2016A2775 (M)  CNC ID: C-16376 CNC ID: C-16386 CNC ID: C-16473  E33-18104 T1350-26-095 D16055003  MSP-CRM-INT-8265NGW	Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com

## Customer Impact of Change and Recommended Action:

The label change does not affect the functionality of the product. Customers should be aware of the changes and take any necessary steps to insure no impact for their receiving and processing of the product in their manufacturing.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
8265.NGWMG	946658	J29831-006	J29831-007
8265.NGWMG.NV	949399	J29844-006	J29844-007
8265.NGWMG.S	951075	J29895-006	J29895-007
8265.NGWMG.NVS	951076	J29902-006	J29902-007
8265.NGWMG.K	951820	J31538-007	J31538-008
8265.NGWMG.NVK	951821	J31579-007	J31579-008
8265.NGWMG.DTX1	958156	J58529-003 (DTX TA) J29831-006 ( Module TA)	J58529-003 (DTX TA) J29831-007 ( Module TA)

## PCN Revision History:

Date of Revision:	Revision Number:	Reason:
October 16, 2018	00	Originally Published PCN
December 13, 2018	01	Adding Product Code 8265.NGWMG.DTX1



# Product Change Notification

## 116550 - 01

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

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